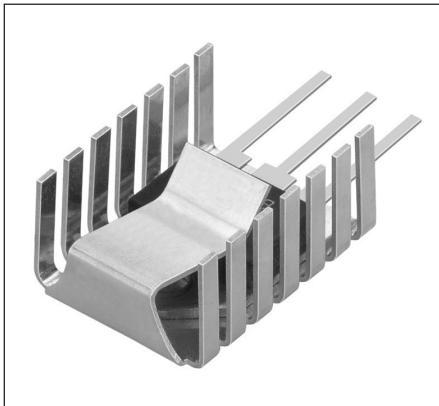


Aufsteckkühlkörper

Clip-on heatsinks

Dissipateurs enfichables



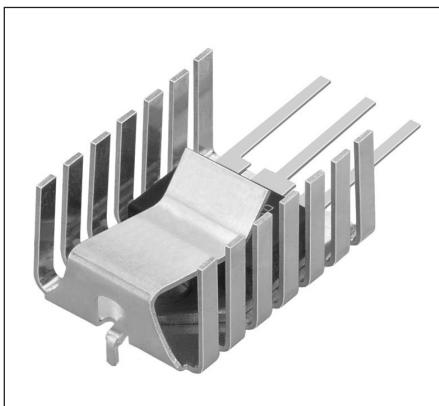
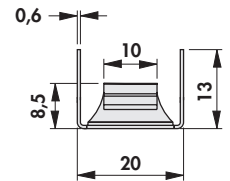
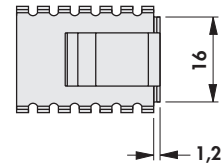
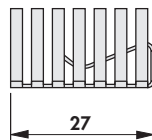
FK 243 MI 247 O

ohne Lötflanke

18,7 K/W

without solder lug

sans paillette picot



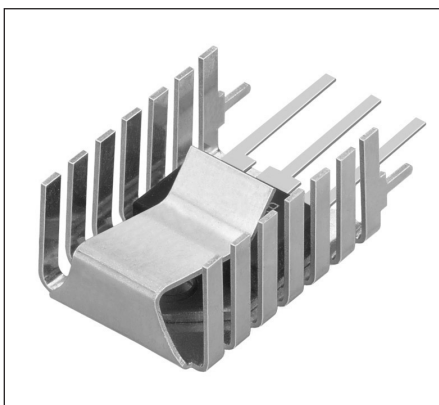
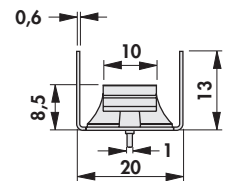
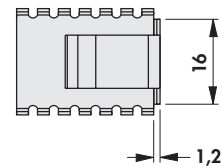
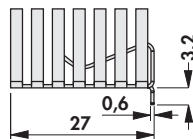
FK 243 MI 247 H

mit Lötflanke für horizontalen Einbau

19 K/W

with solder lug for horizontal installation

avec paillette picot pour montage horizontal



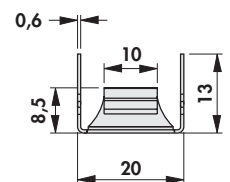
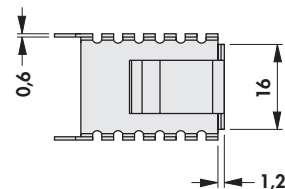
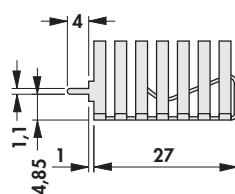
FK 243 MI 247 V

mit Lötflanke für vertikalen Einbau

18,4 K/W

with solder lug for vertical installation

avec paillette picot pour montage vertical



Material: Kupfer (Cu), 0,6 mm dick
Oberfläche: lötfähig

Material: copper (Cu), 0,6 mm thick
Surface: solderable

Matériau: Cuivre (Cu), épaisseur 0,6 mm
Revêtement: Soudable

Kühlkörper für Transistoren
im Plastikgehäuse
Strangkühlkörper mit Lötstiften
U-Kühlkörper

Heatsinks for transistors
in plastic case
Extruded heatsinks with solder Pins
U-shaped heatsinks

Dissipateurs pour transistors
en boîtier plastique
Dissipateurs extrudés avec broches à souder
Dissipateurs en U

→ C 5 – 10
→ A 97 – 114
→ A 122 – 124

C 14